

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lay bed ON Semiconductor and its officers, employees, ween if such claim alleges that ON Semiconductor was negligent regarding the d

www.onsemi.com

ON Semiconductor[®]



FDMS2D5N08C N-Channel Shielded Gate PowerTrench[®] MOSFET 80 V, 166 A, 2.7 mΩ

Features

- Shielded Gate MOSFET Technology
- Max r_{DS(on)} = 2.7 mΩ at V_{GS} = 10 V, I_D = 68 A
- Max $r_{DS(on)}$ = 6.7 m Ω at V_{GS} = 6 V, I_D = 34 A
- 50% lower Qrr than other MOSFET suppliers
- Lowers switching noise/EMI
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

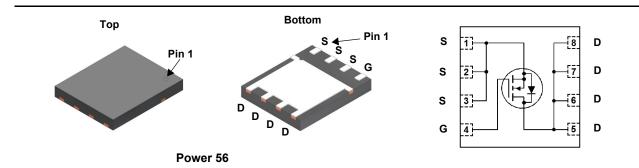


General Description

This N-Channel MV MOSFET is produced using ON Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized to minimise on-state resistance and yet maintain superior switching performance with best in class soft body diode.

Applications

- Primary DC-DC MOSFET
- Synchronous Rectifier in DC-DC and AC-DC
- Motor Drive
- Solar



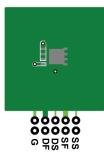
MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol		F	Ratings		Units					
V _{DS}	Drain to	Drain to Source Voltage						V		
V _{GS}	Gate to	Gate to Source Voltage						V		
ID	Drain Cu	urrent -Continuous	T _C	_c = 25 °C	(Note 5)	166				
	-Continuous			_c = 100 °C	(Note 5)	105		Α		
	-Continuous			= 25 °C	(Note 1a)	24				
	-Pulsed (Note 4)					823				
E _{AS}	Single F	Single Pulse Avalanche Energy (Note 3)				600		mJ		
P _D	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$				138		W			
	Power D	Dissipation	T _A	= 25 °C	(Note 1a)	2.7	vv			
T _J , T _{STG}	Operatir	ng and Storage Junction Te	-55 to +150		°C					
Thermal Cl						0.0				
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case					0.9		°C/W		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient(Note 1a)					45				
Package M	arking a	nd Ordering Informa	ation							
Device Marking		Device	Package	Ree	el Size	Tape Width		Quantity		
FDMS2D5N08C		FDMS2D5N08C	Power 56		13 "	12 mm	3000 units			

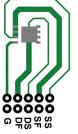
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	80			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		62		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 64 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			100	nA
On Chara	octeristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 380 μA	2.0	2.9	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 380 μ A, referenced to 25 °C		-8.3		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 68 A		2.2	2.7	
	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 34 A		3.3	6.7	mΩ
		V_{GS} = 10 V, I _D = 68 A, T _J = 125 °C		3.7	4.5	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 68 A		148		S
C _{iss}	Characteristics Input Capacitance Output Capacitance			4455	6240	pF
C _{oss}	Output Capacitance	-f = 1 MHz		1480	2070	pF
C _{rss}	Reverse Transfer Capacitance			59	85	pF
R _g	Gate Resistance			0.8	1.6	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			21	34	ns
t _r	Rise Time	V _{DD} = 40 V, I _D = 68 A,		11	20	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		29	47	ns
t _f	Fall Time			7	13	ns
Qg	Total Gate Charge	V_{GS} = 0 V to 10 V		60	84	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V$ $V_{DD} = 40 V$,		38	54	nC
Q _{gs}	Gate to Source Charge	I _D = 68 A		19		nC
Q _{gd}	Gate to Drain "Miller" Charge			12		nC
Q _{oss}	Output Charge	V_{DD} = 40 V, V_{GS} = 0 V		84		nC
Q _{sync}	Total Gate Charge Sync	V _{DS} = 0 V, I _D = 68 A		51		nC
Drain-Sou	urce Diode Characteristics					
N/	Source to Drain Diada, Ecourad Maltana	$V_{GS} = 0 V, I_S = 2.2 A$ (Note 2)		0.7	1.2	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 68 A$ (Note 2)		0.8	1.3	
t _{rr}	Reverse Recovery Time			30	48	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 34 A, di/dt = 300 A/μs		55	88	nC
						1

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design

 $I_F = 34 \text{ A}, \text{ di/dt} = 1000 \text{ A/}\mu\text{s}$



a. 45 °C/W when mounted on a 1 in² pad of 2 oz copper.



b. 115 °C/W when mounted on a

minimum pad of 2 oz copper.

24

139

39

222

ns

nC

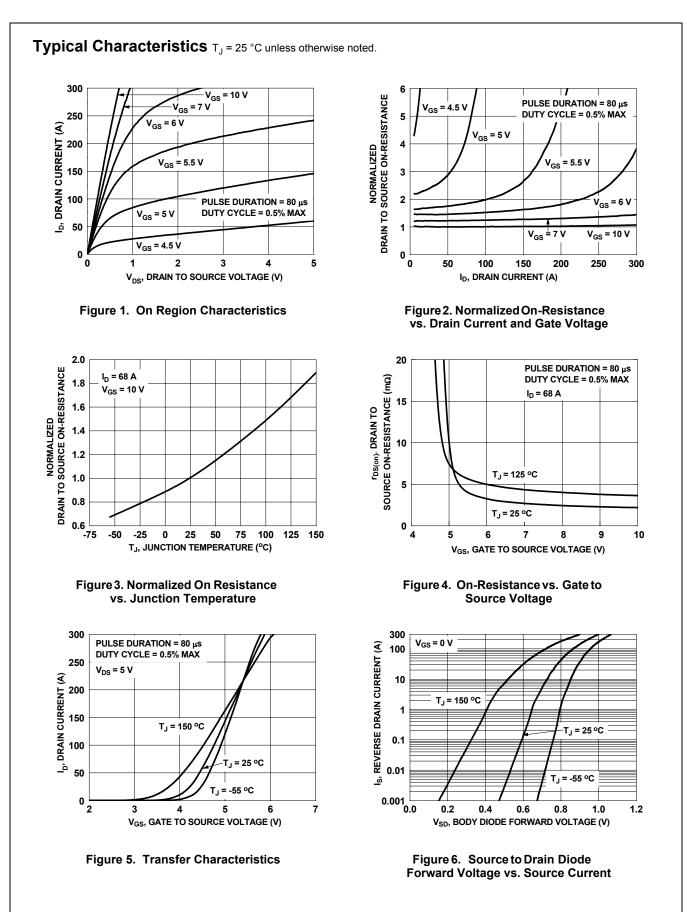
FDMS2D5N08C N-Channel Shielded Gate PowerTrench[®] MOSFET

www.onsemi.com

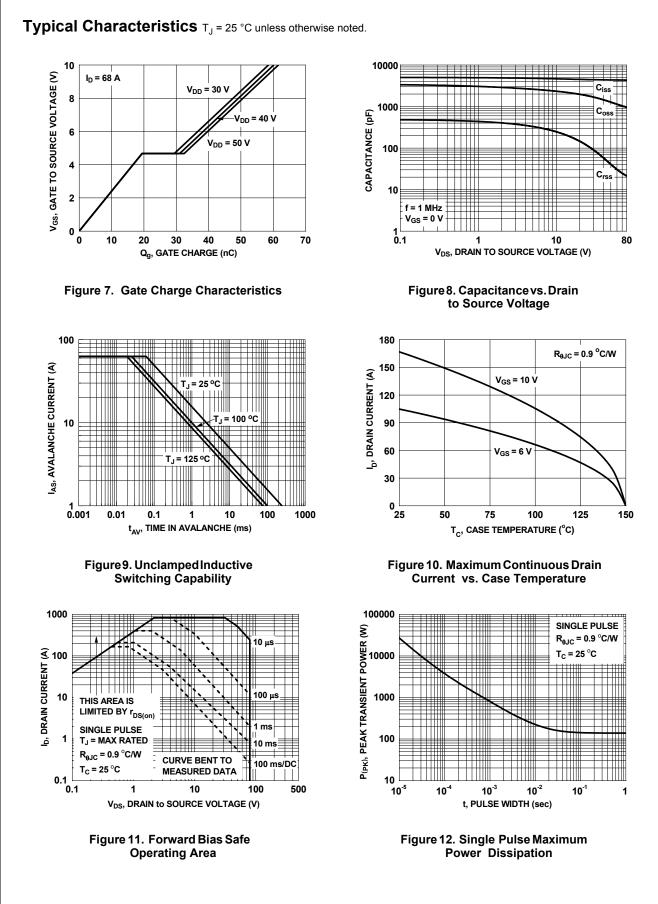
Reverse Recovery Time

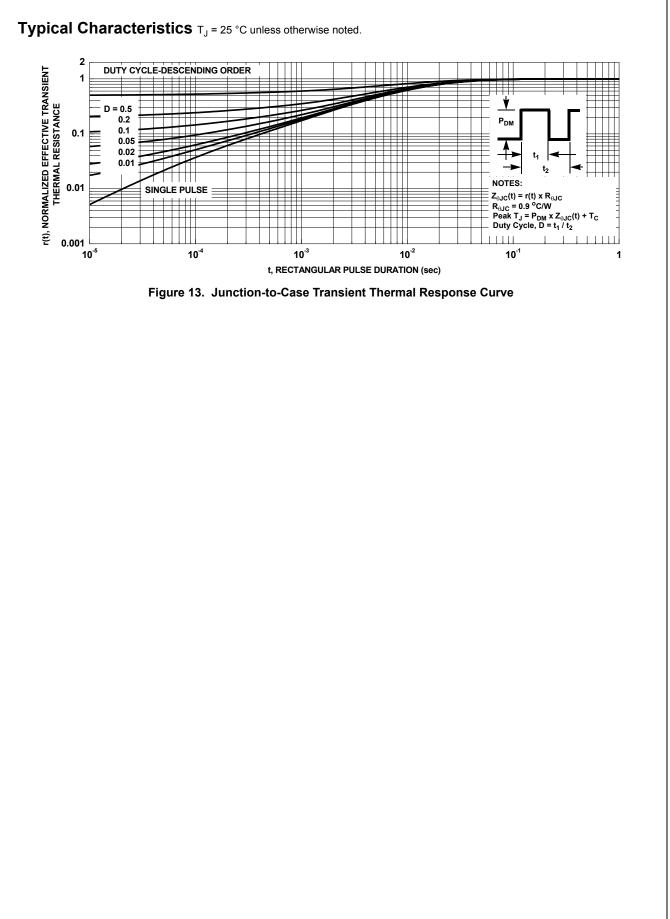
Reverse Recovery Charge

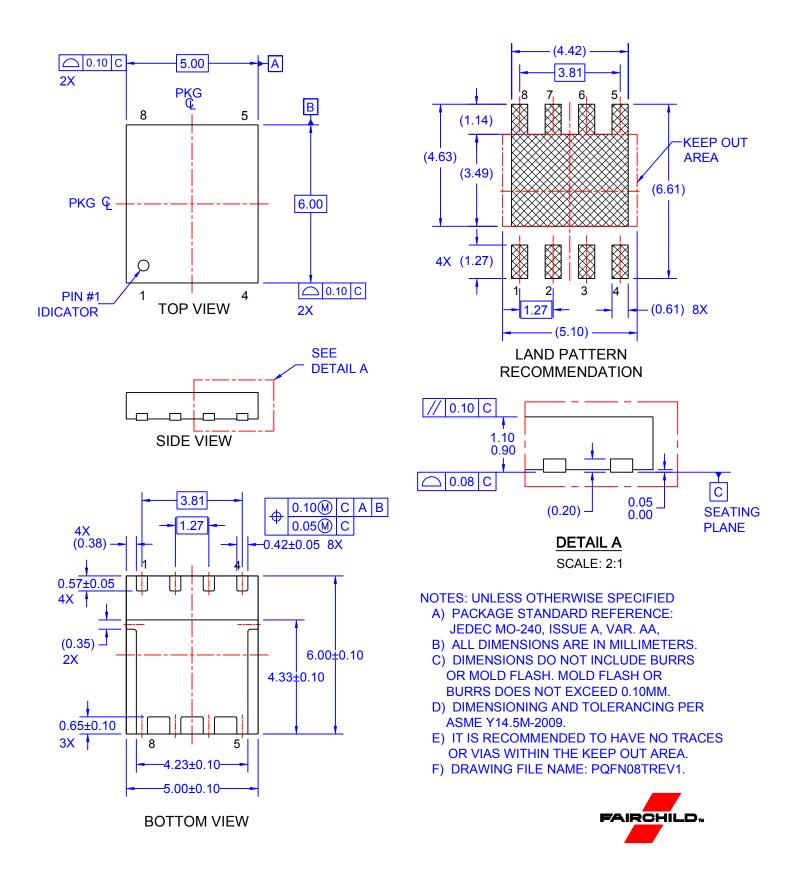
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
 E_{AS} of 600 mJ is based on starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 20 A, V_{DD} = 80 V, V_{GS} =10 V. 100% test at L = 0.1 mH, I_{AS} = 63 A.
 Pulsed Id please refer to Fig 11 SOA graph for more details.
 Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.











ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B